

Discription

The HSTN101050BL25 protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.

Features

- ★ Transient protection for high-speed data lines IEC 61000-4-2(ESD) ±8kV (Contact) ±15kV (Air)
 IEC 61000-4-4(EFT) 40A (5/50 ns)
- ★ Peak power dissipation: 100W (8/20us)
- ★ Working voltages : 5V
- ★ Ultra-small package (1.0mmx0.6mmx0.5mm)
- ★ Protects one I/0 line
- ★ Low clamping voltage
- ★ Low leakage current

Orderingin formation



DFN1006-2L

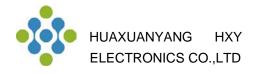
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Circuit Diagram

Product ID	Pack	Qty(PCS)
HSTN101050BL25	DFN1006-2L	10000

Absolute Ratings(Tamb = 25°C)

Symbol	Parameter	Value	Units
P _{PP}	Peak Pulse Power ($t_p = 8/20 \ \mu \ s$)	100	W
TL	Maximum lead temperature for soldering during 10s		°C
T _{stg}	tg Storage Temperature Range		°C
T _{op}	Operating Temperature Range	-55 to +150	°C
Tj	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharg contact discharg		KV
	IEC61000-4-4 (EFT)	40	А

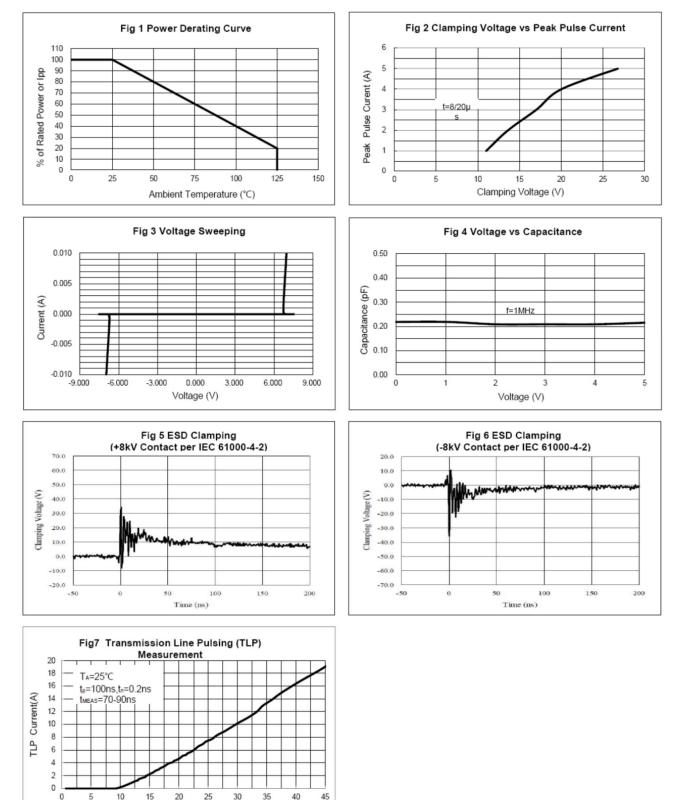


Electrical Characteristics Ratings at 25°C

Symbol	Parameter	Test Condition	Min	Тур	Max	Units
Vrwm	Reverse Working Voltage				5.0	V
Vbr	Reverse Breakdown Voltage	l⊤ = 1mA	6.0			V
IR	Reverse Leakage Current	$V_{RWM} = 5.0V$			0.1	μA
Vc	Clamping Voltage	$I_{RWM} = 1A, t_{P} = 8/20 \mu s$			13	V
VC		$I_{RWM} = 4A, t_{P} = 8/20 \mu s$			25	V
	Contact, ±8kV Air)	26		V		
Vctlp	TLP Clamping Voltage	IPP = 16A IEC61000-4-2 Level 4 equivalent (±8kV Contact, ±16kV Air)		38		
CJ	Junction Capacitance	$V_R = 0V, f = 1MHz$		0.5		pF



Typical Characteristics



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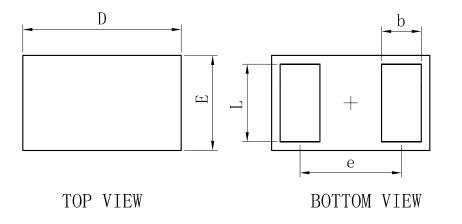
TLP Voltage(V)

0

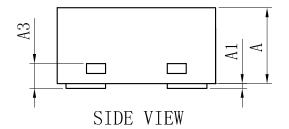
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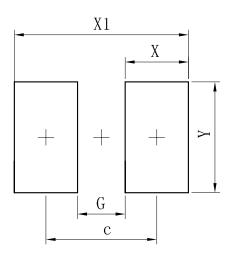
Outline And Dimensions



DFN1006-2L				
Dim	Min	Тур	Max	
D	0.95	1.00	1.05	
Е	0.55	0.60	0.65	
е	-	0.64	-	
L	0.44	0.49	0.54	
b	0.20	0.25	0.30	
A	0.43	0.48	0.53	
A1	0	0.05		
A3	0. 127REF.			
All Dimensions in mm				



Soledering Footprint



Dimensions	(mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Y	0.70



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